

## STGP30NC60W STGW30NC60W

N-channel 30A - 600V - TO-247 - TO-220 Ultra fast switching PowerMESH™ IGBT

#### **General features**

Туре	V <sub>CES</sub>	V <sub>CE(sat)</sub> Max @25°C	I <sub>C</sub> @100°C
STGW30NC60W	600V	< 2.5V	30A
STGP30NC60W	600V	< 2.5V	30A

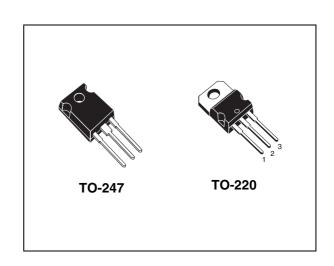
- High frequency operation
- Lower C<sub>RES</sub> / C<sub>IES</sub> ratio (no cross-conduction susceptibility)
- Very soft ultra fast recovery antiparallel diode
- Short circuit withstand time 10µs



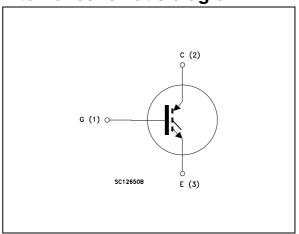
Using the latest high voltage technology based on a patented strip layout, STMicroelectronics has designed an advanced family of IGBTs, the PowerMESH<sup>™</sup> IGBTs, with outstanding performances. The suffix "W" identifies a family optimized for very high frequency application.

### **Applications**

- High frequency motor controls, inverters, ups
- HF, SMPS and PFC in both hard switch and resonant topologies



### Internal schematic diagram



### **Order codes**

Part number	Marking	Package	Packaging
STGW30NC60W	GW30NC60W	TO-247	Tube
STGP30NC60W	GP30NC60W	TO-220	Tube

## **Contents**

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## 1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>CES</sub>	Collector-emitter voltage (V <sub>GS</sub> = 0)	600	V
I <sub>C</sub>	Collector current (continuous) at 25°C	60	Α
I <sub>C</sub>	Collector current (continuous) at 100°C	30	Α
I <sub>CM</sub> <sup>(1)</sup>	Collector current (pulsed)	200	Α
V <sub>GE</sub>	Gate-emitter voltage	± 20	V
P <sub>TOT</sub>	Total dissipation at T <sub>C</sub> = 25°C	200	W
T <sub>stg</sub>	Storage temperature	– 55 to 150	°C
T <sub>j</sub>	Operating junction temperature	- 55 10 150	
T <sub>L</sub>	Maximum lead temperature for soldering purpose (1.6mm from case, for 10 sec.)	300	°C

<sup>1.</sup> Pulse width limited by max junction temperature

Table 2. Thermal resistance

			Min.	Тур.	Max.	Unit
Rthj-case	Thermal resistance junction-case				0.625	°C/W
Rthj-amb	Thermal resistance junction-ambient	TO-220 TO-247			62.5 50	°C/W

## 2 Electrical characteristics

(T<sub>CASE</sub>=25°C unless otherwise specified)

Table 3. Static

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>BR(CES)</sub>	Collector-emitter $I_C = 1 \text{mA}, V_{GE} = 0$		600			٧
V <sub>CE(SAT)</sub>	Collector-emitter saturation voltage	V <sub>GE</sub> =15V, I <sub>C</sub> = 20A, Tj= 25°C V <sub>GE</sub> =15V, I <sub>C</sub> = 20A, Tj= 125°C		2.1 1.8	2.5	V V
V <sub>GE(th)</sub>	Gate threshold voltage	$V_{CE} = V_{GE}, I_{C} = 250 \mu A$	3.75		5.75	V
I <sub>CES</sub>	Collector-emitter leakage current (V <sub>CE</sub> = 0)	V <sub>CE</sub> = Max rating,Tc=25°C V <sub>CE</sub> = Max rating, Tc=125°C			10 1	μA mA
I <sub>GES</sub>	Gate-emitter leakage current (V <sub>CE</sub> = 0)	V <sub>GE</sub> = ±20V , V <sub>CE</sub> = 0			± 100	nA
9 <sub>fs</sub>	Forward transconductance	V <sub>CE</sub> = 15V <sub>,</sub> I <sub>C</sub> = 20A		15		S

Table 4. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>ies</sub> C <sub>oes</sub> C <sub>res</sub>	Input capacitance Output capacitance Reverse transfer capacitance	V <sub>CE</sub> = 25V, f = 1MHz, V <sub>GE</sub> =0		2080 175 52		pF pF pF
Q <sub>g</sub> Q <sub>ge</sub> Q <sub>gc</sub>	Total gate charge Gate-emitter charge Gate-collector charge	$V_{CE}$ = 390V, $I_{C}$ = 20A, $V_{GE}$ = 15V, (see Figure 16)		102 17.5 47	140	nC nC nC
I <sub>CL</sub>	Turn-Off SOA minimum current	$V_{clamp} = 480V$ , $Tj = 150$ °C $R_G = 10\Omega$ , $V_{GE} = 15V$	200			А

Table 5. Switching on/off (inductive load)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time Current rise time	$V_{CC} = 390V, I_{C} = 20A$ $R_{G} = 10\Omega, V_{GF} = 15V,$		29.5 12		ns ns
(di/dt) <sub>on</sub>	Turn-on current slope	T <sub>J</sub> = 25°C <i>(see Figure 15)</i>		1640		A/µs
t <sub>d(on)</sub> t <sub>r</sub> (di/dt) <sub>on</sub>	Turn-on delay time Current rise time Turn-on current slope	$V_{CC}$ = 390V, $I_{C}$ = 20A $R_{G}$ = 10 $\Omega$ $V_{GE}$ = 15V, $T_{J}$ = 125°C (see Figure 15)		29 13.5 1600		ns ns A/µs
t <sub>r</sub> (V <sub>off</sub> ) t <sub>d</sub> ( <sub>off</sub> ) t <sub>f</sub>	Off voltage rise time Turn-off delay time Current fall time	$V_{cc}$ = 390V, $I_{C}$ = 20A, $R_{GE}$ = 10 $\Omega$ , $V_{GE}$ = 15V $T_{J}$ =25°C (see Figure 17)		19.5 118 27		ns ns ns
t <sub>r</sub> (V <sub>off</sub> ) t <sub>d</sub> ( <sub>off</sub> ) t <sub>f</sub>	Off voltage rise time Turn-off delay time Current fall time	$V_{cc} = 390 \text{V}, I_{C} = 20 \text{A},$ $R_{GE} = 10 \Omega, V_{GE} = 15 \text{V},$ $T_{J} = 125 ^{\circ}\text{C}$ (see Figure 17)		46 151 38		ns ns ns

Table 6. Switching energy (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
E <sub>on</sub> <sup>(1)</sup> E <sub>off</sub> <sup>(2)</sup> E <sub>ts</sub>	Turn-on switching losses Turn-off switching losses Total switching losses	$V_{CC}$ = 390V, $I_{C}$ = 20A $R_{G}$ = 10 $\Omega$ $V_{GE}$ = 15V, $T_{J}$ = 25°C (see Figure 17)		116 181 297		μJ μJ μJ
E <sub>on</sub> <sup>(1)</sup> E <sub>off</sub> <sup>(2)</sup> E <sub>ts</sub>	Turn-on switching losses Turn-off switching losses Total switching losses	$V_{CC}$ = 390V, $I_{C}$ = 20A $R_{G}$ = 10 $\Omega$ , $V_{GE}$ = 15V, $T_{J}$ = 125°C (see Figure 17)		239 355 594		μJ μJ μJ

Eon is the tun-on losses when a typical diode is used in the test circuit in figure 2. If the IGBT is offered in a package with a co-pak diode, the co-pack diode is used as external diode. IGBTs & Diode are at the same temperature (25°C and 125°C)

<sup>2.</sup> Turn-off losses include also the tail of the collector current

### 2.1 Electrical characteristics (curves)

Figure 1. Output characterisics

Figure 2. Transfer characteristics

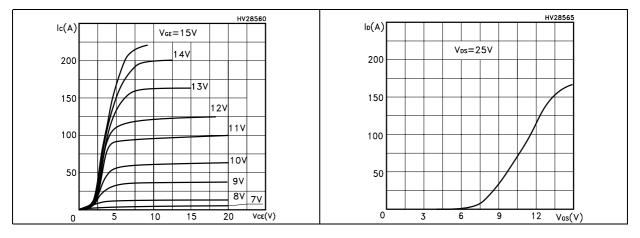


Figure 3. Transconductance

Figure 4. Collector-emitter on voltage vs temperature

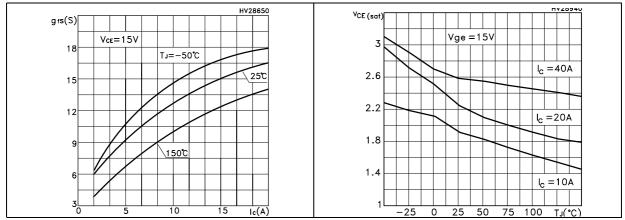


Figure 5. Gate charge vs gate-source voltage Figure 6. Capacitance variations

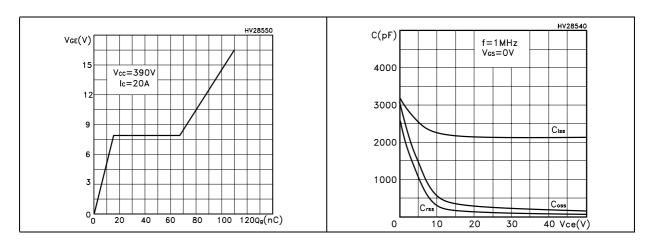


Figure 7. Normalized gate threshold voltage Figure 8. Collector-emitter on voltage vs vs temperature collector current

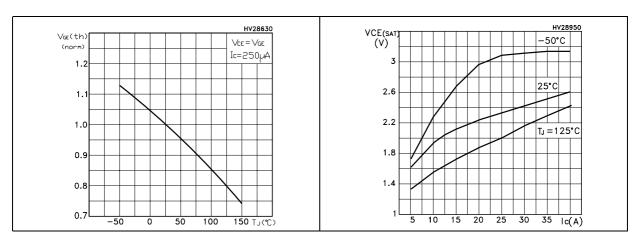


Figure 9. Normalized breakdown voltage vs Figure 10. Switching losses vs temperature temperature

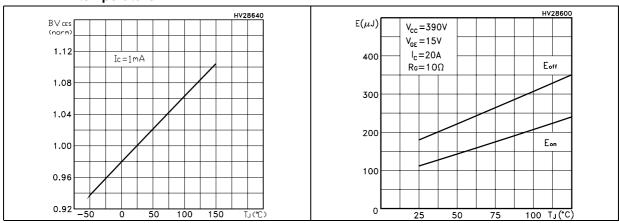
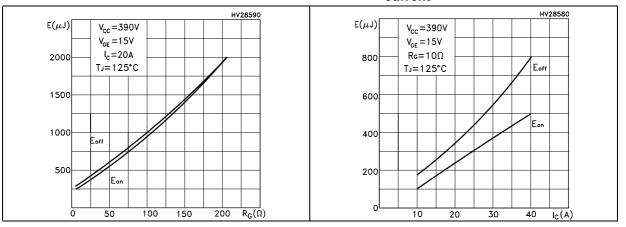


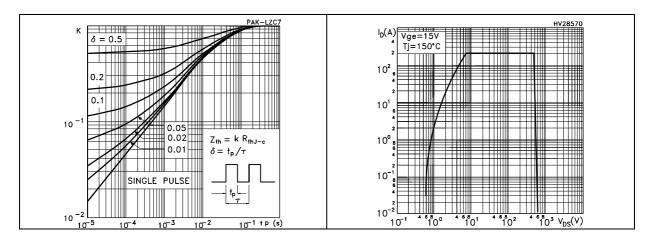
Figure 11. Switching losses vs gate resistance Figure 12. Switching losses vs collector current



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Figure 13. Thermal impedance

Figure 14. Turn-off SOA



## 3 Test circuit

Figure 15. Test circuit for inductive load switching

Figure 16. Gate charge test circuit

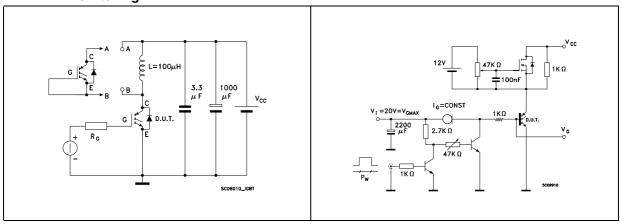
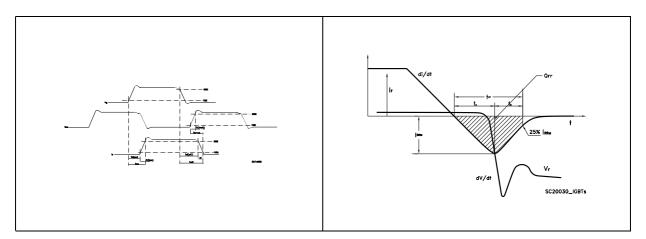


Figure 17. Switching waveform

Figure 18. Diode recovery time waveform

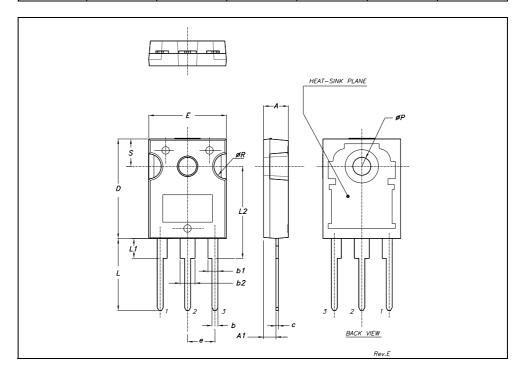


## 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: <a href="https://www.st.com">www.st.com</a>

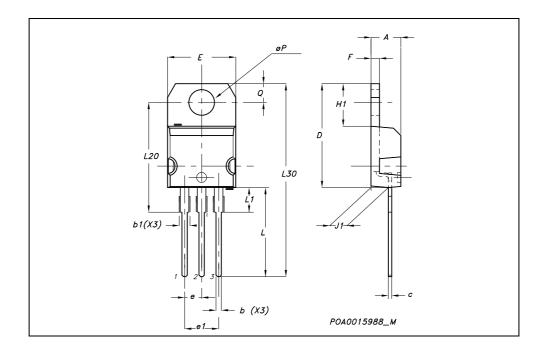
#### **TO-247 MECHANICAL DATA**

DIM.		mm.			inch	
DIIVI.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
Α	4.85		5.15	0.19		0.20
A1	2.20		2.60	0.086		0.102
b	1.0		1.40	0.039		0.055
b1	2.0		2.40	0.079		0.094
b2	3.0		3.40	0.118		0.134
С	0.40		0.80	0.015		0.03
D	19.85		20.15	0.781		0.793
E	15.45		15.75	0.608		0.620
е		5.45			0.214	
L	14.20		14.80	0.560		0.582
L1	3.70		4.30	0.14		0.17
L2		18.50			0.728	
øΡ	3.55		3.65	0.140		0.143
øR	4.50		5.50	0.177		0.216
S		5.50			0.216	



#### **TO-220 MECHANICAL DATA**

5114		mm.			inch	
DIM.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
Α	4.40		4.60	0.173		0.181
b	0.61		0.88	0.024		0.034
b1	1.15		1.70	0.045		0.066
С	0.49		0.70	0.019		0.027
D	15.25		15.75	0.60		0.620
E	10		10.40	0.393		0.409
е	2.40		2.70	0.094		0.106
e1	4.95		5.15	0.194		0.202
F	1.23		1.32	0.048		0.052
H1	6.20		6.60	0.244		0.256
J1	2.40		2.72	0.094		0.107
L	13		14	0.511		0.551
L1	3.50		3.93	0.137		0.154
L20		16.40			0.645	
L30		28.90			1.137	
øΡ	3.75		3.85	0.147		0.151
Q	2.65		2.95	0.104		0.116



# 5 Revision history

Table 7. Revision history

Date	Revision	Changes
15-Sep-2005	1	Initial release.
04-Jan-2006	2	Inserted TO-220. Complete version
18-Dec-2006	3	The document has been reformatted

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